

SMD Type

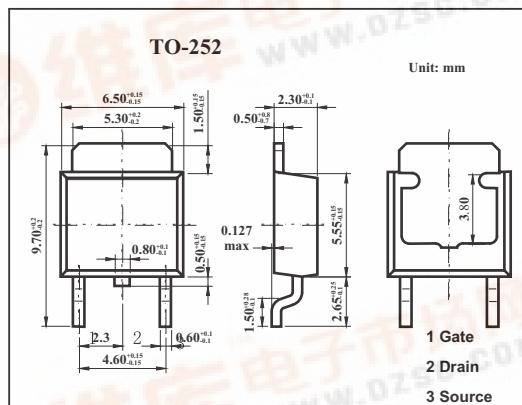
MOSFET

MOS Field Effect Transistor

2SK3365

■ Features

- Super low on-state resistance:
- $R_{DS(on)1} = 14 \text{ m}\Omega \text{ MAX. } (V_{GS} = 10 \text{ V}, I_D = 15 \text{ A})$
- $R_{DS(on)2} = 21 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A})$
- $R_{DS(on)3} = 29 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4 \text{ V}, I_D = 15 \text{ A})$
- Low C_{iss}: C_{iss} = 1300 pF TYP.
- Built-in gate protection diode



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	±30	A
	I _{DP} *	±120	A
Power dissipation T _A =25°C T _C =25°C	P _D	1.0	W
		36	
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW≤10 μ s,Duty Cycle≤1%

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain cut-off current	I _{DS}	V _D =30V,V _G =0			10	μA
Gate leakage current	I _{GSS}	V _G =±20V,V _D =0			±10	μA
Gat cutoff voltage	V _{GS(off)}	V _D =10V,I _D =1mA	1.5	2.0	2.5	V
Forward transfer admittance	Y _{fs}	V _D =10V,I _D =15A	8.0	16.0		S
Drain to source on-state resistance	R _{DS(on)}	V _G =10V,I _D =15A		11.5	14	mΩ
		V _G =4.5V,I _D =15A		15.2	21	mΩ
		V _G =4.0V,I _D =15A		18	29	mΩ
Input capacitance	C _{iss}	V _D =10V,V _G =0,f=1MHZ		1300		pF
Output capacitance	C _{oss}			405		pF
Reverse transfer capacitance	C _{rss}			190		pF
Turn-on delay time	t _{on}	I _D =15A,V _G (on)=10V,R _G =10Ω,V _D =15V		37		ns
Rise time	t _r			500		ns
Turn-off delay time	t _{off}			75		ns
Fall time	t _f			95		ns
Total Gate Charge	Q _G	V _D = 24V, V _G = 10 V, I _D = 30A		25		nC
Gate to Source Charge	Q _{GS}			4.5		nC
Gate to Drain Charge	Q _{GD}			7.0		nC